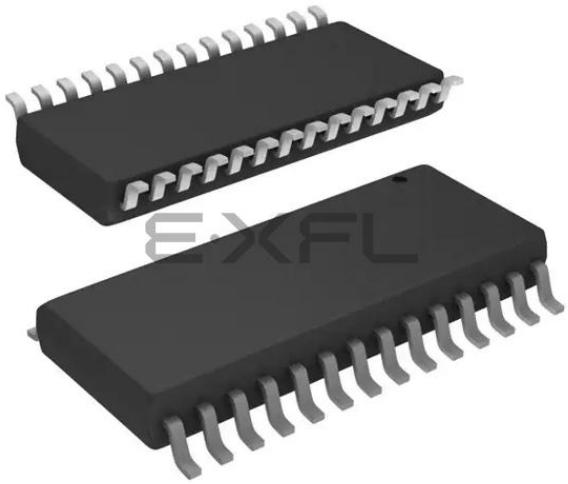


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I²S, LVD, POR, PWM, WDT
Number of I/O	22
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj128ga702-i-so

NOTES:

TABLE 1-1: DEVICE FEATURES FOR THE PIC24FJXXXGA702: 28-PIN DEVICES

Features	PIC24FJ64GA702	PIC24FJ128GA702	PIC24FJ256GA702
Operating Frequency	DC – 32 MHz		
Program Memory (bytes)	64K	128K	256K
Program Memory (instruction words, 24 bits)	22,528	45,056	88,064
Data Memory (bytes)	16K		
Interrupt Sources (soft vectors/NMI traps)	124		
I/O Ports	Ports A, B		
Total I/O Pins	22		
Remappable Pins	18 (18 I/Os, 0 input only)		
DMA	1 6-channel		
16-Bit Timers	3(1)		
Real-Time Clock and Calendar (RTCC)	Yes		
Cyclic Redundancy Check (CRC)	Yes		
Input Capture Channels	3(1)		
Output Compare/PWM Channels	3(1)		
Input Change Notification Interrupt	21 (remappable pins)		
Serial Communications:			
UART	2(1)		
SPI (3-wire/4-wire)	3(1)		
I^2C	2		
Configurable Logic Cell (CLC)	2(1)		
Parallel Communications (EPMP/PSP)	No		
Capture/Compare/PWM/Timer Modules	4 Multiple CCPs 1 (6-output), 3 (2-output)		
JTAG Boundary Scan	Yes		
10/12-Bit Analog-to-Digital Converter (A/D) Module (input channels)	10		
Analog Comparators	3		
CTMU Interface	Yes		
Universal Serial Bus Controller	No		
Resets (and Delays)	Core POR, VDD POR, BOR, RESET Instruction, $\overline{MCLR}$, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (OST, PLL Lock)		
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations		
Packages	28-Pin QFN, UQFN, SOIC, SSOP and SPDIP		

Note 1: Some peripherals are accessible through remappable pins.

2.4.1 CONSIDERATIONS FOR CERAMIC CAPACITORS

In recent years, large value, low-voltage, surface-mount ceramic capacitors have become very cost effective in sizes up to a few tens of microfarad. The low-ESR, small physical size and other properties make ceramic capacitors very attractive in many types of applications.

Ceramic capacitors are suitable for use with the internal voltage regulator of this microcontroller. However, some care is needed in selecting the capacitor to ensure that it maintains sufficient capacitance over the intended operating range of the application.

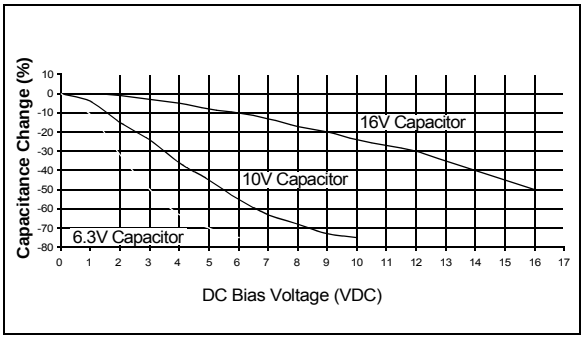
Typical low-cost, 10 μF ceramic capacitors are available in X5R, X7R and Y5V dielectric ratings (other types are also available, but are less common). The initial tolerance specifications for these types of capacitors are often specified as ±10% to ±20% (X5R and X7R) or -20%/+80% (Y5V). However, the effective capacitance that these capacitors provide in an application circuit will also vary based on additional factors, such as the applied DC bias voltage and the temperature. The total in-circuit tolerance is, therefore, much wider than the initial tolerance specification.

The X5R and X7R capacitors typically exhibit satisfactory temperature stability (ex: ±15% over a wide temperature range, but consult the manufacturer's data sheets for exact specifications). However, Y5V capacitors typically have extreme temperature tolerance specifications of +22%/-82%. Due to the extreme temperature tolerance, a 10 μF nominal rated Y5V type capacitor may not deliver enough total capacitance to meet minimum internal voltage regulator stability and transient response requirements. Therefore, Y5V capacitors are not recommended for use with the internal regulator if the application must operate over a wide temperature range.

In addition to temperature tolerance, the effective capacitance of large value ceramic capacitors can vary substantially, based on the amount of DC voltage applied to the capacitor. This effect can be very significant, but is often overlooked or is not always documented.

A typical DC bias voltage vs. capacitance graph for X7R type capacitors is shown in Figure 2-4.

FIGURE 2-4: DC BIAS VOLTAGE vs. CAPACITANCE CHARACTERISTICS



When selecting a ceramic capacitor to be used with the internal voltage regulator, it is suggested to select a high-voltage rating so that the operating voltage is a small percentage of the maximum rated capacitor voltage. For example, choose a ceramic capacitor rated at a minimum of 16V for the 1.8V core voltage. Suggested capacitors are shown in Table 2-1.

2.5 ICSP Pins

The PGCx and PGDx pins are used for In-Circuit Serial Programming (ICSP) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω.

Pull-up resistors, series diodes and capacitors on the PGCx and PGDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin Voltage Input High (V_{IH}) and Voltage Input Low (V_{IL}) requirements.

For device emulation, ensure that the "Communication Channel Select" pins (i.e., PGCx/PGDx) programmed into the device match the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 30.0 "Development Support"**.

4.0 MEMORY ORGANIZATION

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"PIC24F Flash Program Memory"** (DS30009715), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

As Harvard architecture devices, PIC24F microcontrollers feature separate program and data memory spaces and buses. This architecture also allows direct access of program memory from the Data Space during code execution.

4.1 Program Memory Space

The program address memory space of the PIC24FJ256GA705 family devices is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from table operation or Data Space remapping, as described in **Section 4.3 "Interfacing Program and Data Memory Spaces"**.

User access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFFh). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and customer OTP sections of the configuration memory space.

The memory map for the PIC24FJ256GA705 family of devices is shown in Figure 4-1.

TABLE 4-4: SFR MAP: 0000h BLOCK

File Name	Address	All Resets	File Name	Address	All Resets
CPU CORE			**INTERRUPT CONTROLLER (CONTINUED)**		
WREG0	0000	0000	IEC1	009A	0000
WREG1	0002	0000	IEC2	009C	0000
WREG2	0004	0000	IEC3	009E	0000
WREG3	0006	0000	IEC4	00A0	0000
WREG4	0008	0000	IEC5	00A2	0000
WREG5	000A	0000	IEC6	00A4	0000
WREG6	000C	0000	IEC7	00A6	0000
WREG7	000E	0000	IPC0	00A8	4444
WREG8	0010	0000	IPC1	00AA	4444
WREG9	0012	0000	IPC2	00AC	4444
WREG10	0014	0000	IPC3	00AE	4444
WREG11	0016	0000	IPC4	00B0	4444
WREG12	0018	0000	IPC5	00B2	4404
WREG13	001A	0000	IPC6	00B4	4444
WREG14	001C	0000	IPC7	00B6	4444
WREG15	001E	0800	IPC8	00B8	0044
SPLIM	0020	xxxx	IPC9	00BA	4444
PCL	002E	0000	IPC10	00BC	4444
PCH	0030	0000	IPC11	00BE	4444
DSRPAG	0032	0000	IPC12	00C0	4444
DSWPAG	0034	0000	IPC13	00C2	0440
RCOUNT	0036	xxxx	IPC14	00C4	4400
SR	0042	0000	IPC15	00C6	4444
CORCON	0044	0004	IPC16	00C8	4444
DISICNT	0052	xxxx	IPC17	00CA	4444
TBLPAG	0054	0000	IPC18	00CC	0044
INTERRUPT CONTROLLER			IPC19	00CE	0040
INTCON1	0080	0000	IPC20	00D0	4440
INTCON2	0082	8000	IPC21	00D2	4444
INTCON4	0086	0000	IPC22	00D4	4444
IFS0	0088	0000	IPC23	00D6	4400
IFS1	008A	0000	IPC24	00D8	4444
IFS2	008C	0000	IPC25	00DA	0440
IFS3	008E	0000	IPC26	00DC	0400
IFS4	0090	0000	IPC27	00DE	4440
IFS5	0092	0000	IPC28	00E0	4444
IFS6	0094	0000	IPC29	00E2	0044
IFS7	0096	0000	INTTREG	00E4	0000
IEC0	0098	0000			

Legend: x = undefined. Reset values are shown in hexadecimal.

REGISTER 10-3: PMD3: PERIPHERAL MODULE DISABLE REGISTER 3

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	CMPMD	RTCCMD	PMPMD
bit 15							bit 8

R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
CRCMD	—	—	—	—	—	I2C2MD	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-11 **Unimplemented:** Read as '0'

bit 10 **CMPMD:** Triple Comparator Module Disable bit
1 = Module is disabled
0 = Module power and clock sources are enabled

bit 9 **RTCCMD:** RTCC Module Disable bit
1 = Module is disabled
0 = Module power and clock sources are enabled

bit 8 **PMPMD:** Enhanced Parallel Master Port Disable bit
1 = Module is disabled
0 = Module power and clock sources are enabled

bit 7 **CRCMD:** CRC Module Disable bit
1 = Module is disabled
0 = Module power and clock sources are enabled

bit 6-2 **Unimplemented:** Read as '0'

bit 1 **I2C2MD:** I2C2 Module Disable bit
1 = Module is disabled
0 = Module power and clock sources are enabled

bit 0 **Unimplemented:** Read as '0'

REGISTER 11-32: RPOR0: PERIPHERAL PIN SELECT OUTPUT REGISTER 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP1R5	RP1R4	RP1R3	RP1R2	RP1R1	RP1R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP0R5	RP0R4	RP0R3	RP0R2	RP0R1	RP0R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP1R<5:0>:** RP1 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP1 (see Table 11-7 for peripheral function numbers).

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP0R<5:0>:** RP0 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP0 (see Table 11-7 for peripheral function numbers).

REGISTER 11-33: RPOR1: PERIPHERAL PIN SELECT OUTPUT REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP3R5	RP3R4	RP3R3	RP3R2	RP3R1	RP3R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP2R5	RP2R4	RP2R3	RP2R2	RP2R1	RP2R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP3R<5:0>:** RP3 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP3 (see Table 11-7 for peripheral function numbers).

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP2R<5:0>:** RP2 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP2 (see Table 11-7 for peripheral function numbers).

REGISTER 11-46: RPOR14: PERIPHERAL PIN SELECT OUTPUT REGISTER 14

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP28R5	RP28R4	RP28R3	RP28R2	RP28R1	RP28R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-6 **Unimplemented:** Read as ‘0’

bit 5-0 **RP28R<5:0>:** RP28 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP28 (see Table 11-7 for peripheral function numbers).

REGISTER 16-8: CCPxSTATH: CCPx STATUS REGISTER HIGH

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0
—	—	—	PRLWIP	TMRHWIP	TMRLWIP	RBWIP	RAWIP
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-5 **Unimplemented:** Read as ‘0’

bit 4 **PRLWIP:** CCPxPRL Write in Progress Status bit
1 = An update to the CCPxPRL register with the buffered contents is in progress
0 = An update to the CCPxPRL register is not in progress

bit 3 **TMRHWIP:** CCPxTMRH Write in Progress Status Bit
1 = An update to the CCPxTMRH register with the buffered contents is in progress
0 = An update to the CCPxTMRH register is not in progress.

bit 2 **TMRLWIP:** CCPxTMRL Write in Progress Status bit
1 = An update to the CCPxTMRL register with the buffered contents is in progress
0 = An update to the CCPxTMRL register is not in progress

bit 1 **RBWIP:** CCPxRB Write in Progress Status bit
1 = An update to the CCPxRB register with the buffered contents is in progress
0 = An update to the CCPxRB register is not in progress

bit 0 **RAWIP:** CCPxRA Write in Progress Status bit
1 = An update to the CCPxRA register with the buffered contents is in progress
0 = An update to the CCPxRA register is not in progress

REGISTER 17-5: SPIxSTATH: SPIx STATUS REGISTER HIGH

U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
—	—	RXELM5(3)	RXELM4(2)	RXELM3(1)	RXELM2	RXELM1	RXELM0
bit 15							bit 8

U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
—	—	TXELM5(3)	TXELM4(2)	TXELM3(1)	TXELM2	TXELM1	TXELM0
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RXELM<5:0>:** Receive Buffer Element Count bits (valid in Enhanced Buffer mode)(1,2,3)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **TXELM<5:0>:** Transmit Buffer Element Count bits (valid in Enhanced Buffer mode)(1,2,3)

Note 1: RXELM3 and TXELM3 bits are only present when FIFODEPTH = 8 or higher.

2: RXELM4 and TXELM4 bits are only present when FIFODEPTH = 16 or higher.

3: RXELM5 and TXELM5 bits are only present when FIFODEPTH = 32.

REGISTER 17-11: SPIxURDTL: SPIx UNDERRUN DATA REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
URDATA<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
URDATA<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **URDATA<15:0>:** SPIx Underrun Data bits

These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs.

When the MODE<32,16> or WLENGTH<4:0> bits select 16 to 9-bit data, the SPIx only uses URDATA<15:0>. When the MODE<32,16> or WLENGTH<4:0> bits select 8 to 2-bit data, the SPIx only uses URDATA<7:0>.

REGISTER 17-12: SPIxURDTH: SPIx UNDERRUN DATA REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
URDATA<31:24>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
URDATA<23:16>							
bit 7							bit 0

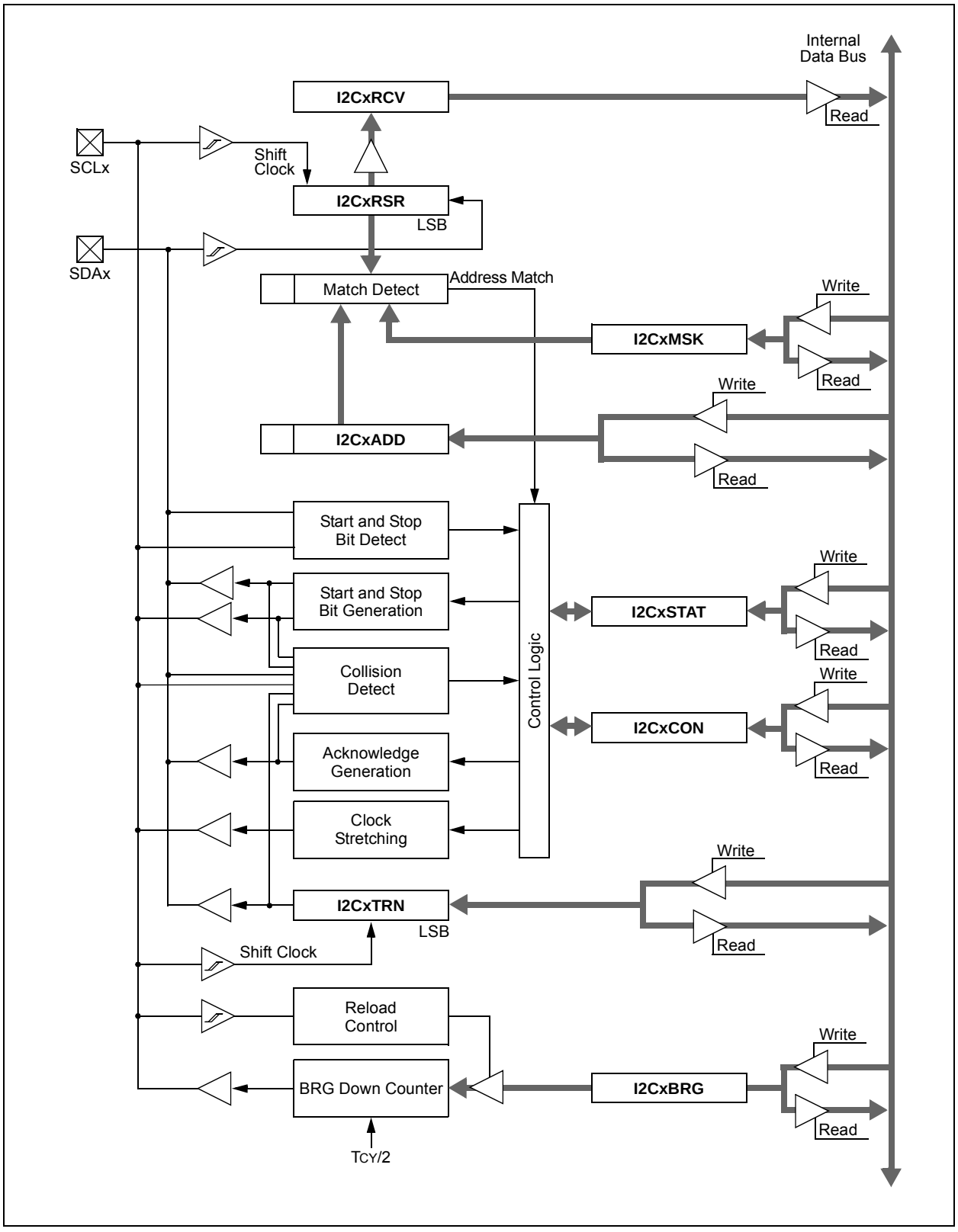
Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **URDATA<31:16>:** SPIx Underrun Data bits

These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs.

When the MODE<32,16> or WLENGTH<4:0> bits select 32 to 25-bit data, the SPIx only uses URDATA<31:16>. When the MODE<32,16> or WLENGTH<4:0> bits select 24 to 17-bit data, the SPIx only uses URDATA<23:16>.

FIGURE 18-1: I2Cx BLOCK DIAGRAM



REGISTER 20-7: PMCSxMD: EPMP CHIP SELECT x MODE REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
ACKM1	ACKM0	AMWAIT2	AMWAIT1	AMWAIT0	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DWAITB1	DWAITB0	DWAITM3	DWAITM2	DWAITM1	DWAITM0	DWAITE1	DWAITE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **ACKM<1:0>:** Chip Select x Acknowledge Mode bits
11 = Reserved
10 = PMACKx is used to determine when a read/write operation is complete
01 = PMACKx is used to determine when a read/write operation is complete with time-out
(If DWAITM<3:0> = 0000, the maximum time-out is 255 TCY or else it is DWAITM<3:0> cycles.)
00 = PMACKx is not used

bit 13-11 **AMWAIT<2:0>:** Chip Select x Alternate Master Wait State bits
111 = Wait of 10 alternate master cycles
. . .
001 = Wait of 4 alternate master cycles
000 = Wait of 3 alternate master cycles

bit 10-8 **Unimplemented:** Read as '0'

bit 7-6 **DWAITB<1:0>:** Chip Select x Data Setup Before Read/Write Strobe Wait State bits
11 = Wait of 3¼ TCY
10 = Wait of 2¼ TCY
01 = Wait of 1¼ TCY
00 = Wait of ¼ TCY

bit 5-2 **DWAITM<3:0>:** Chip Select x Data Read/Write Strobe Wait State bits
For Write Operations:
1111 = Wait of 15½ TCY
. . .
0001 = Wait of 1½ TCY
0000 = Wait of ½ TCY
For Read Operations:
1111 = Wait of 15¾ TCY
. . .
0001 = Wait of 1¾ TCY
0000 = Wait of ¾ TCY

bit 1-0 **DWAITE<1:0>:** Chip Select x Data Hold After Read/Write Strobe Wait State bits
For Write Operations:
11 = Wait of 3¼ TCY
10 = Wait of 2¼ TCY
01 = Wait of 1¼ TCY
00 = Wait of ¼ TCY
For Read Operations:
11 = Wait of 3 TCY
10 = Wait of 2 TCY
01 = Wait of 1 TCY
00 = Wait of 0 TCY

21.3.2 RTCVAL REGISTER MAPPINGS

REGISTER 21-4: RTCCON2H: RTCC CONTROL REGISTER 2 (HIGH)(1)

R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
DIV<15:8>							
bit 15							bit 8

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
DIV<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **DIV<15:0>:** Clock Divide bits
Sets the period of the clock divider counter; value should cause a nominal 1/2 second underflow.

Note 1: A write to this register is only allowed when WRLOCK = 1.

TABLE 23-1: MODULE-SPECIFIC INPUT DATA SOURCES

Bit Field Value		Input Source	
		CLC1	CLC2
DS4<2:0>	011	SDI1	SDI2
	001	CLC2 Output	CLC1 Output
DS3<2:0>	100	U1RX	U2RX
	011	SDO1	SDO2
	001	CLC1 Output	CLC2 Output
DS2<2:0>	011	U1TX	U2TX
	001	CLC2 Output	CLC1 Output

REGISTER 23-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G2D4T	G2D4N	G2D3T	G2D3N	G2D2T	G2D2N	G2D1T	G2D1N
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G1D4T	G1D4N	G1D3T	G1D3N	G1D2T	G1D2N	G1D1T	G1D1N
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **G2D4T:** Gate 2 Data Source 4 True Enable bit
1 = The Data Source 4 signal is enabled for Gate 2
0 = The Data Source 4 signal is disabled for Gate 2

bit 14 **G2D4N:** Gate 2 Data Source 4 Negated Enable bit
1 = The Data Source 4 inverted signal is enabled for Gate 2
0 = The Data Source 4 inverted signal is disabled for Gate 2

bit 13 **G2D3T:** Gate 2 Data Source 3 True Enable bit
1 = The Data Source 3 signal is enabled for Gate 2
0 = The Data Source 3 signal is disabled for Gate 2

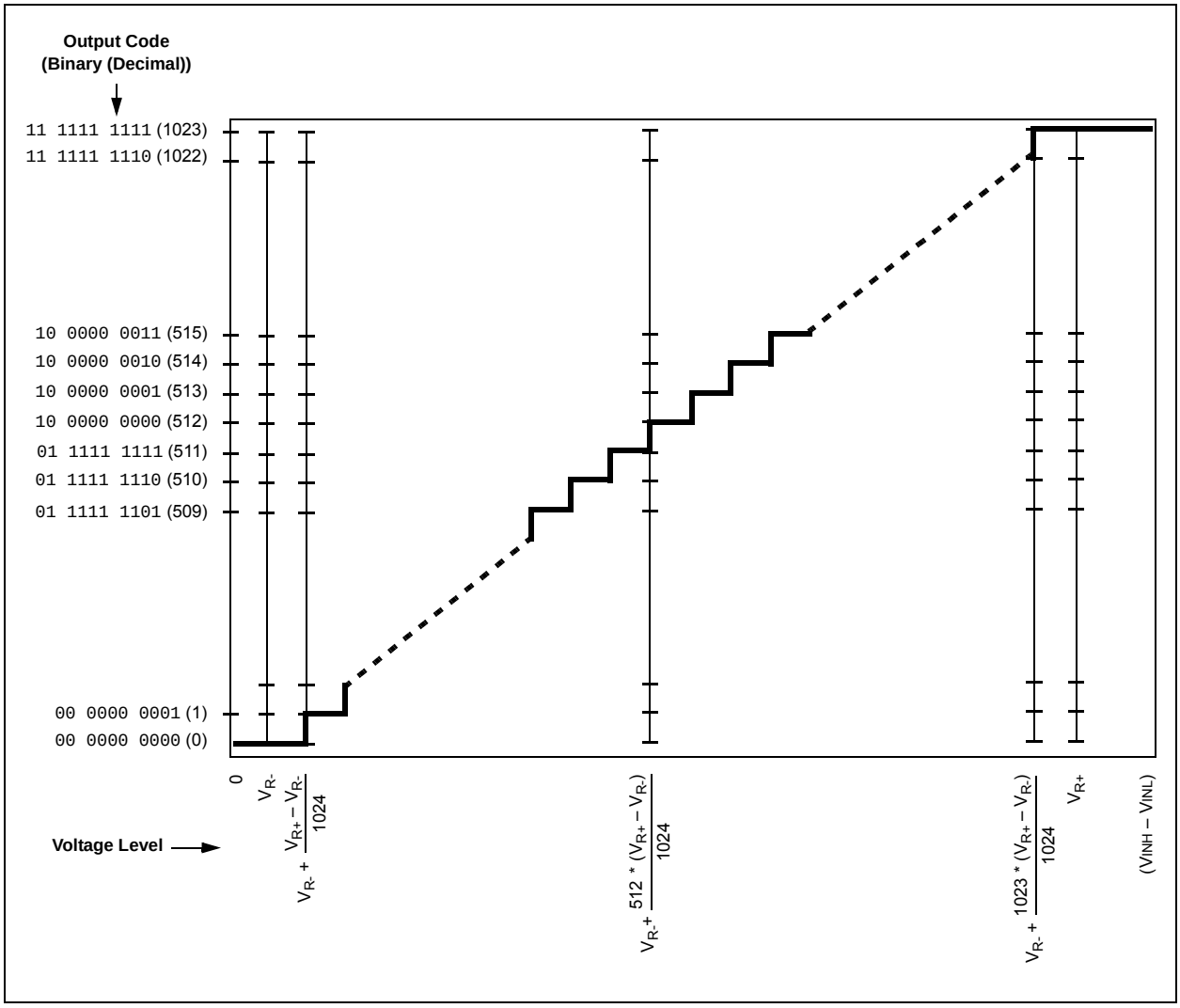
bit 12 **G2D3N:** Gate 2 Data Source 3 Negated Enable bit
1 = The Data Source 3 inverted signal is enabled for Gate 2
0 = The Data Source 3 inverted signal is disabled for Gate 2

bit 11 **G2D2T:** Gate 2 Data Source 2 True Enable bit
1 = The Data Source 2 signal is enabled for Gate 2
0 = The Data Source 2 signal is disabled for Gate 2

bit 10 **G2D2N:** Gate 2 Data Source 2 Negated Enable bit
1 = The Data Source 2 inverted signal is enabled for Gate 2
0 = The Data Source 2 inverted signal is disabled for Gate 2

bit 9 **G2D1T:** Gate 2 Data Source 1 True Enable bit
1 = The Data Source 1 signal is enabled for Gate 2
0 = The Data Source 1 signal is disabled for Gate 2

FIGURE 24-5: 10-BIT A/D TRANSFER FUNCTION



REGISTER 29-5: FOSC CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
FCKSM1	FCKSM0	IOL1WAY	PLLSS	SOSCSEL	OSCIOFCN	POSCMD1	POSCMD0
bit 7							bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 23-8 **Unimplemented:** Read as ‘1’

bit 7-6 **FCKSM<1:0>:** Clock Switching and Monitor Selection bits
1x = Clock switching and the Fail-Safe Clock Monitor are disabled
01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled
00 = Clock switching and the Fail-Safe Clock Monitor are enabled

bit 5 **IOL1WAY:** Peripheral Pin Select Configuration bit
1 = The IOLOCK bit can be set only once (with unlock sequence).
0 = The IOLOCK bit can be set and cleared as needed (with unlock sequence)

bit 4 **PLLSS:** PLL Secondary Selection Configuration bit
This Configuration bit only takes effect when the PLL is NOT being used by the system (i.e., not selected as part of the system clock source). Used to generate an independent clock out of REFO.
1 = PLL is fed by the Primary Oscillator
0 = PLL is fed by the on-chip Fast RC (FRC) Oscillator

bit 3 **SOSCSEL:** SOSC Selection Configuration bit
1 = Crystal (SOSCI/SOSCO) mode
0 = Digital (SOSCI) Externally Supplied Clock mode

bit 2 **OSCIOFCN:** CLKO Enable Configuration bit
1 = CLKO output signal is active on the OSCO pin (when the Primary Oscillator is disabled or configured for EC mode)
0 = CLKO output is disabled

bit 1-0 **POSCMD<1:0>:** Primary Oscillator Configuration bits
11 = Primary Oscillator mode is disabled
10 = HS Oscillator mode is selected (10 MHz-32 MHz)
01 = XT Oscillator mode is selected (1.5 MHz-10 MHz)
00 = External Clock mode is selected

TABLE 32-9: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param No.	Symbol	Characteristic	Min	Typ(1)	Max	Units	Conditions
	VOL	**Output Low Voltage**					
DO10		I/O Ports	—	—	0.4	V	IOL = 6.6 mA, VDD = 3.6V
			—	—	0.8	V	IOL = 18 mA, VDD = 3.6V
			—	—	0.35	V	IOL = 5.0 mA, VDD = 2V
DO16		OSCO/CLKO	—	—	0.18	V	IOL = 6.6 mA, VDD = 3.6V
			—	—	0.2	V	IOL = 5.0 mA, VDD = 2V
	VOH	**Output High Voltage**					
DO20		I/O Ports	3.4	—	—	V	IOH = -3.0 mA, VDD = 3.6V
			3.25	—	—	V	IOH = -6.0 mA, VDD = 3.6V
			2.8	—	—	V	IOH = -18 mA, VDD = 3.6V
			1.65	—	—	V	IOH = -1.0 mA, VDD = 2V
			1.4	—	—	V	IOH = -3.0 mA, VDD = 2V
DO26		OSCO/CLKO	3.3	—	—	V	IOH = -6.0 mA, VDD = 3.6V
			1.85	—	—	V	IOH = -1.0 mA, VDD = 2V

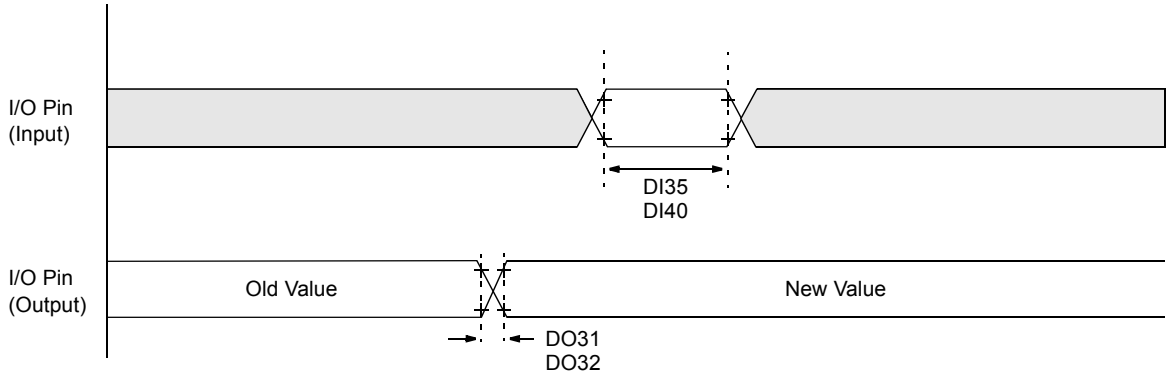
Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 32-10: DC CHARACTERISTICS: PROGRAM MEMORY

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param No.	Symbol	Characteristic	Min	Typ(1)	Max	Units	Conditions
		Program Flash Memory					
D130	EP	Cell Endurance	10000	—	—	E/W	-40°C to +85°C
D131	VPR	VDD for Read	VMIN	—	3.6	V	VMIN = Minimum operating voltage
D132B		VDD for Self-Timed Write	VMIN	—	3.6	V	VMIN = Minimum operating voltage
D133A	TIW	Self-Timed Word Write Cycle Time	—	20	—	µs	
		Self-Timed Row Write Cycle Time	—	1.5	—	ms	
D133B	TIE	Self-Timed Page Erase Time	20	—	40	ms	
D134	TRETD	Characteristic Retention	20	—	—	Year	If no other specifications are violated
D135	IDDP	Supply Current during Programming	—	5	—	mA	

Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated.

FIGURE 32-4: CLKO AND I/O TIMING CHARACTERISTICS



Note: Refer to Figure 32-2 for load conditions.

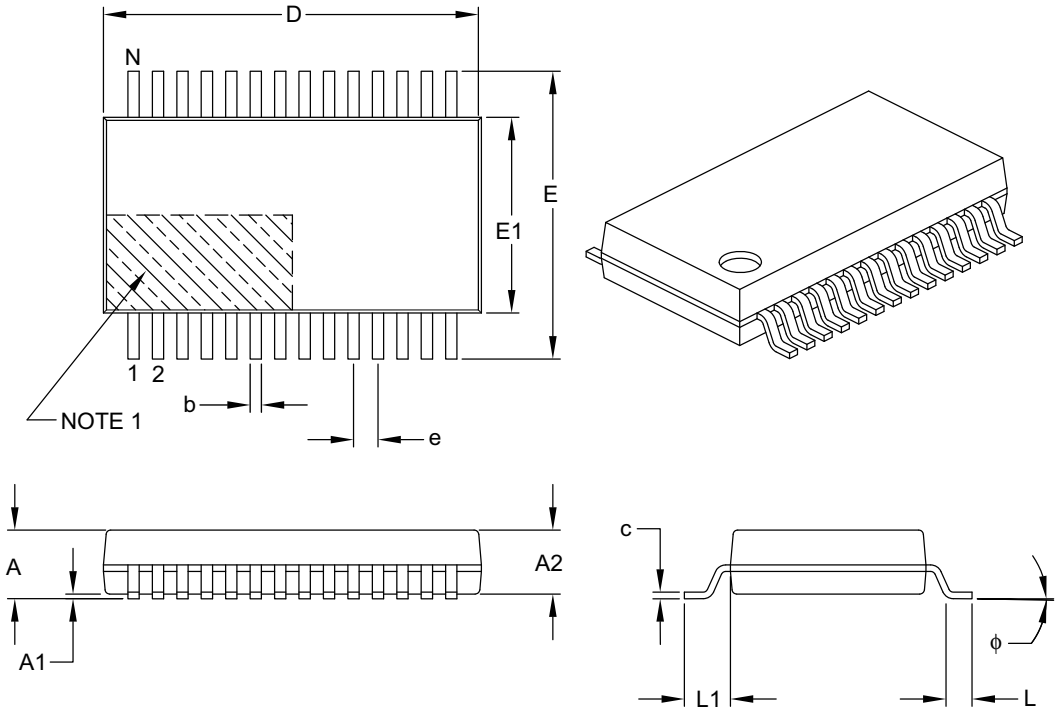
TABLE 32-22: CLKO AND I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
DO31	TIOR	Port Output Rise Time	—	10	25	ns	
DO32	TIOF	Port Output Fall Time	—	10	25	ns	
DI35	TINP	INTx Pin High or Low Time (input)	1	—	—	TCY	
DI40	TRBP	CNx High or Low Time (input)	1	—	—	TCY	

Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated.

28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	–	–	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	–	–
Overall Width	E	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	9.90	10.20	10.50
Foot Length	L	0.55	0.75	0.95
Footprint	L1		1.25 REF	
Lead Thickness	c	0.09	–	0.25
Foot Angle	ϕ	0°	4°	8°
Lead Width	b	0.22	–	0.38

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B